# plerow<sup>™</sup> APM0942-P29



#### **High OIP3 Medium Power Amplifier Module**

#### **Features**

- · S<sub>21</sub> = 31.4 dB @ 925 MHz
- = 30.6 dB @ 960 MHz
- · NF of 6.6 dB over Frequency
- · Unconditionally Stable
- · Single 5V Supply
- · High OIP3 @ Low Current

#### Description

The plerow<sup>™</sup> APM-Series is an internally matched amplifier mini-module for such application band in SMD package with the output P1dB of 29 dBm. It is compactly designed for low current consumption and high OIP3. Integrating all the components for biasing and matching within the module enhances production yield and throughput as well. It passes through the stringent DC, RF, and reliability tests. Not sample test but 100% quality control test is made before packing.





1-stage Single Type

#### More Information

Website: www.asb.co.kr E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223 Fax: (82) 42-528-7222

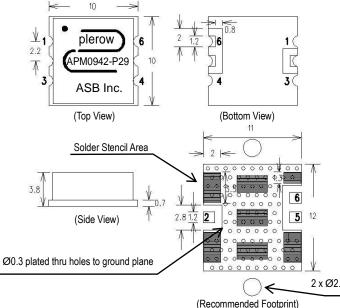
# **Specifications (in Production)**

Typ. @ T =  $25^{\circ}$ C, V<sub>s</sub> = 5 V, Freq. = 942.5 MHz, Z<sub>o.sys</sub> = 50 ohm Specifications Parameter Unit Min Тур Max Frequency Range 925 960 MHz Gain dB 30 31 Gain Flatness dB ± 0.4 ± 0.5 Noise Figure dB 6.6 6.8 Output IP3<sup>(1)</sup> dBm 44 47 S11 / S22 (2) dB -14 / -9 Output P1dB dBm 28 29 Switching Time (3) μsec -Supply Current mΑ 370 400 Supply Voltage V 5 Impedance Ω 50 Max. RF Input Power dBm C.W 23 ~ 25 (before fail) Package Type & Size mm Surface Mount Type, 10Wx10Lx3.8H

Operating temperature is -40°C to +85°C.

OIP3 is measured with two tones at an output power of 12 dBm / tone separated by 1 MHz.
S11/S22 (max) is the worst value within the frequency band.
Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V<sub>S</sub>.

# **Outline Drawing (Unit: mm)**



Pin Number	Function	
2	RF In	
5	RF Out	
6	Vs	
Others	Ground	

Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

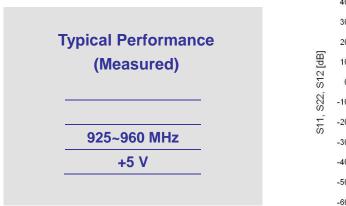
2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

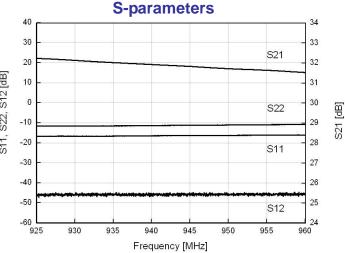
2 x Ø2.0 plated thru holes to screw on heat sinker



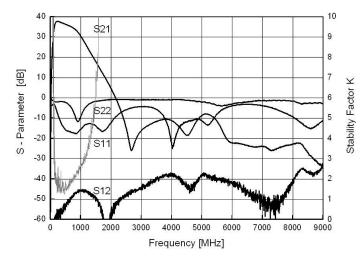
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### High OIP3 Medium Power Amplifier Module

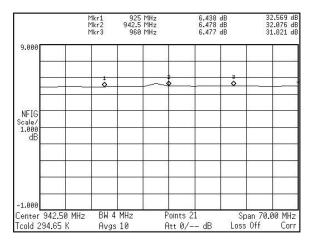




**Stability Factor (K)** 



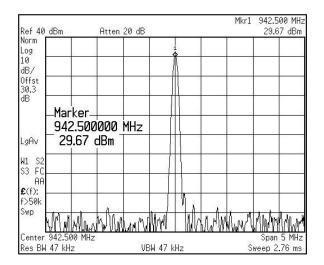




#### OIP3

Intermod (TOI)	00000 MHz		B
Ref 12.3 dBm #	Atten 12 dB	*	
Log 10	<u> </u>		
dB/			
offst 30.3 dB		┿┹╄┷┿	
Center 942.500 MHz Res BW 47 kHz		kHz	Span 5 MHz Sweep 8.64 ms
TOI (Worst Case	<b>)</b> 941.0 MHz	47.29 dBm	
TOI lower TOI upper	941.0 MHz 944.0 MHz	47.29 dBm	

#### P1dB

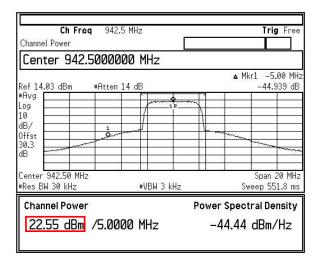


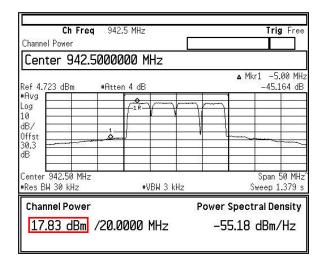


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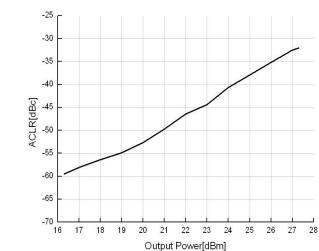
#### **Output Channel Power**

(@ ACLR=-45dBc, +/-5MHz Offset)



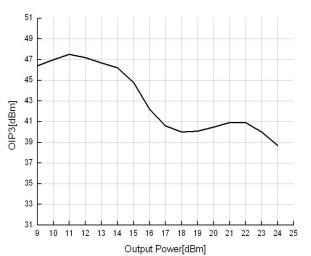


#### **ACLR vs Channel Power**



\*\* Test Source : Agilent E4433B (3GPP W-CDMA Test Model-1 64DPCH)

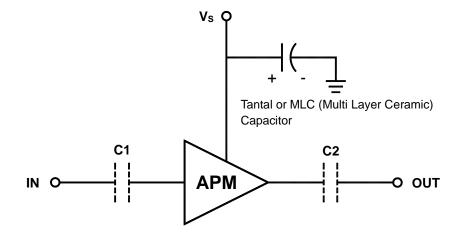
### OIP3 vs Output Power (@ 1MHz offset, 1-tone power)





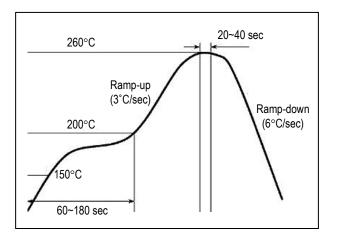
#### High OIP3 Medium Power Amplifier Module

# **Application Circuit**



- The tantal or MLC (Multi Layer Ceramic) capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status. The capacitor should be placed as close as possible to V<sub>s</sub> pin and be connected directly to the ground plane for the best electrical performance.
- 2) DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the APM module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

#### **Recommended Soldering Reflow Process**

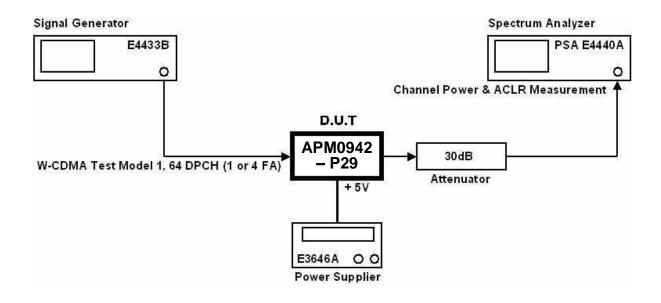


Frequencies – 10x10mm

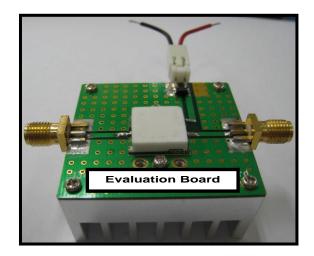


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#### **Channel Power vs. ACLR Test Configuration**



#### **Evaluation Board attached with Heat Sink**



\* In order to prevent damage of D.U.T (APM-Series) from heating, you must to use a properly sized heat sink for testing a module.